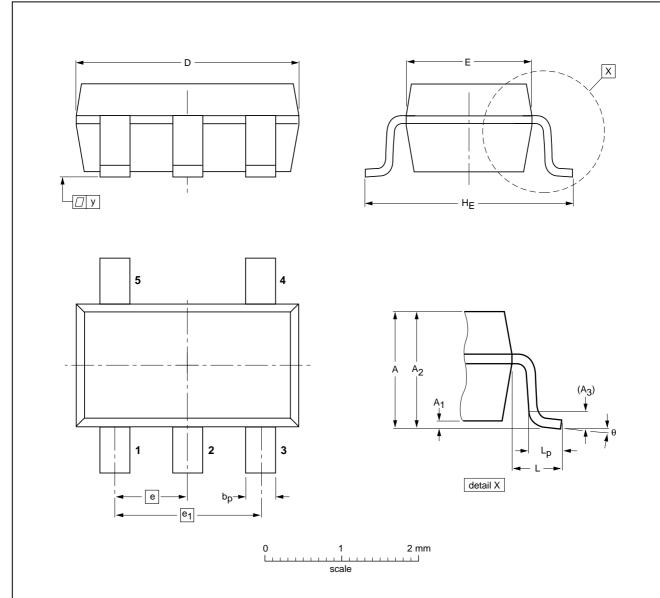
# **Philips Semiconductors**

# Package outline

### Plastic small outline package; 5 leads; body width 1.5 mm

SOT23-5



### DIMENSIONS (mm are the original dimensions)

	· · · · · · · · · · · · · · · · · ·															
UI	TIN	A max.	A <sub>1</sub>	A <sub>2</sub>	А3	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	HE	L	Lp	у	θ
n	ım	1.35	0.15 0.05	1.2 1.0	0.025	0.55 0.41	0.22 0.08	3.1 2.7	3.0 2.7	1.7 1.5	1.90	3.0 2.6	0.6	0.55 0.35	0.1	8° 0°

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT23-5		MO-178				02-10-31	